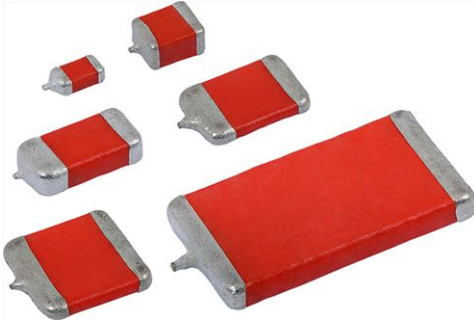


Solid Tantalum Chip Capacitors TANTAMOUNT™, Low Profile, Conformal Coated

Application Specific Pulse Capacitor for Wireless Modems



FEATURES

- Robust design for use in wireless modem applications
- Designed specifically for pulsed operation
- 100 % surge current tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE
GREEN
(5-2008)

PERFORMANCE CHARACTERISTICS

Operating Temperature: -55 °C to +125 °C
(above 40 °C, voltage derating is required)

Capacitance Tolerance: ± 20 % standard

Capacitance Range: 330 µF to 2200 µF

Voltage Rating: 6.3 V_{DC} to 10 V_{DC}

Moisture Sensitivity Level 2a

LINKS TO ADDITIONAL RESOURCES



3D Models



Parametric Search



Calculators

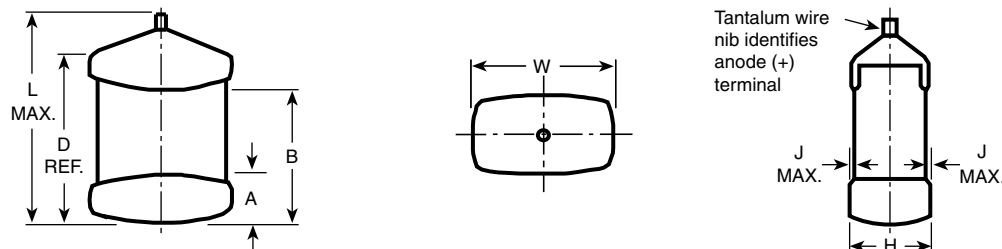
ORDERING INFORMATION

| 592W | 757 | X0 | 010 | M | 2 | T | 20H |
|------|--|-----------------------|--|----------------------------------|---------------|-----------------------------|------------------------------------|
| TYPE | CAPACITANCE | CAPACITANCE TOLERANCE | DC VOLTAGE RATING AT +85 °C | CASE CODE | TERMINATION | REEL SIZE AND PACKAGING | SUFFIX |
| | This is expressed in picofarads. The first two digits are the significant figures. The third is the number of zeros to follow. | X0 = ± 20 % | This is expressed in volts. To complete the three-digit block, zeros precede the voltage rating. A decimal point is indicated by an "R" (6R3 = 6.3 V). | See Ratings and Case Codes table | 2 = 100 % tin | T = 7" [178 mm] reel | Maximum height (mm) see dimensions |

Note

- Preferred tolerance and reel sizes are in bold.
We reserve the right to supply higher voltage ratings and tighter capacitance tolerance capacitors in the same case size

DIMENSIONS in inches [millimeters]



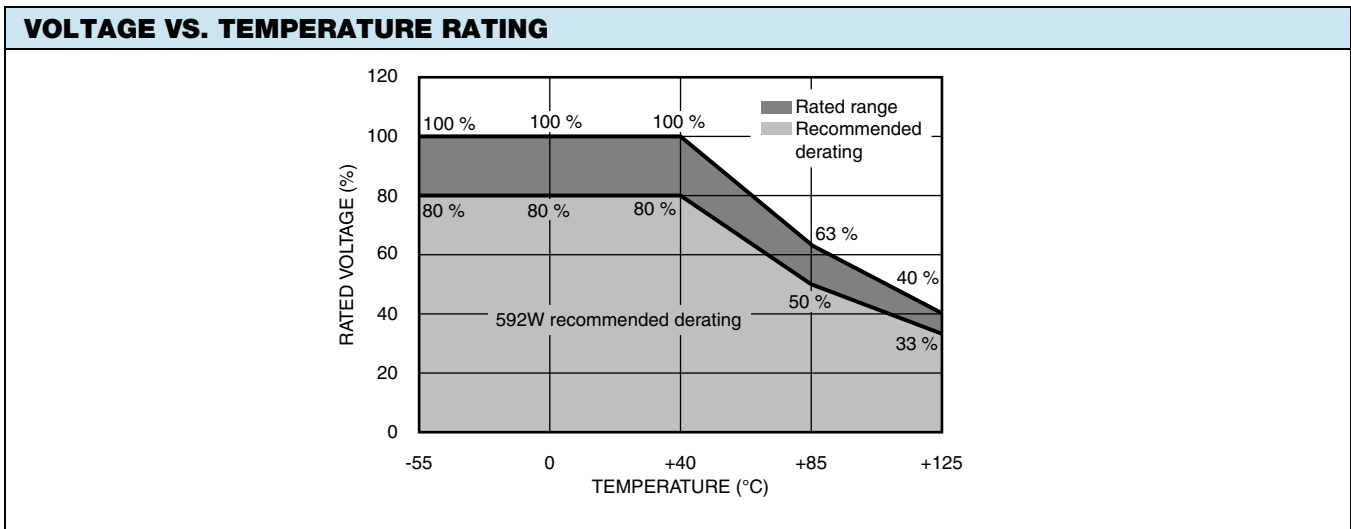
| CASE CODE | SUFFIX | H | L MAX. | W | A | B | D REF. | J MAX. |
|-----------|--------|------------------|--------------|---|---------------------------|----------------------------|--------------|-------------|
| C | 16H | 0.063 [1.6] max. | 0.280 [7.1] | 0.126 ± 0.012 [3.2 ± 0.3] | 0.051 ± 0.012 [1.3 ± 0.3] | 0.173 ± 0.024 [4.4 ± 0.6] | 0.236 [6.0] | 0.004 [0.1] |
| | 20H | 0.079 [2.0] max. | | | | | | |
| M | 20H | 0.063 [1.6] max. | 0.295 [7.5] | 0.248 ± 0.012 [6.3 ± 0.3] | 0.051 ± 0.012 [1.3 ± 0.3] | 0.200 ± 0.024 [5.1 ± 0.6] | 0.264 [6.7] | 0.004 [0.1] |
| | | 0.079 [2.0] max. | | | | | | |
| X | 16H | 0.063 [1.6] max. | 0.571 [14.5] | 0.290 + 0.010 / - 0.020 [7.37 + 0.25 / - 0.5] | 0.051 ± 0.016 [1.3 ± 0.4] | 0.469 ± 0.024 [11.9 ± 0.6] | 0.520 [13.2] | 0.004 [0.1] |
| | 20H | 0.079 [2.0] max. | | | | | | |



| RATINGS AND CASE CODES | | | |
|------------------------|-------|-------|-------|
| μF | 6.3 V | 8.2 V | 10 V |
| 330 | | | C_2.0 |
| 470 | C_1.6 | C_2.0 | |
| 680 | | | |
| 750 | | | M_2.0 |
| 1000 | | | X_2.0 |
| 2200 | X_1.6 | | |

| STANDARD RATINGS | | | | | | |
|--|-----------|--------------------|------------------|-------------------------|------------------------------|--------------------------------|
| CAPACITANCE (μF) | CASE CODE | PART NUMBER | MAX. HEIGHT (mm) | MAX. DCL AT +25 °C (μA) | MAX. DF AT +25 °C 120 Hz (%) | MAX. ESR AT +25 °C 100 kHz (Ω) |
| 6.3 V _{DC} AT +40 °C; 4.0 V _{DC} AT +85 °C; 2.5 V _{DC} AT +125 °C | | | | | | |
| 470 | C | 592W477X06R3C2T16H | 1.6 | 30 | 14 | 0.200 |
| 2200 | X | 592W228X06R3X2T16H | 1.6 | 139 | 45 | 0.070 |
| 8.2 V _{DC} AT +40 °C; 5.2 V _{DC} AT +85 °C; 3.3 V _{DC} AT +125 °C | | | | | | |
| 470 | C | 592W477X08R2C2T20H | 2.0 | 57 | 20 | 0.100 |
| 10 V _{DC} AT +40 °C; 6.3 V _{DC} AT +85 °C; 4.0 V _{DC} AT +125 °C | | | | | | |
| 330 | C | 592W337X0010C2T20H | 2.0 | 33 | 20 | 0.100 |
| 750 | M | 592W757X0010M2T20H | 2.0 | 75 | 35 | 0.100 |
| 1000 | X | 592W108X0010X2T20H | 2.0 | 100 | 35 | 0.080 |

| ELECTRICAL PERFORMANCE CHARACTERISTICS | | | | | | |
|--|--|--------------------|-------|-------|-------|-------|
| ITEM | PERFORMANCE CHARACTERISTICS | | | | | |
| Category temperature range | -55 °C to +125 °C (with voltage derating) | | | | | |
| Capacitance tolerance | ± 20 %, ± 10 % (at 120 Hz) 2 V _{RMS} at +25 °C using a capacitance bridge | | | | | |
| Dissipation factor (at 120 Hz) | Limits per Standard Ratings table. Tested via bridge method, at 25 °C, 120 Hz | | | | | |
| ESR (100 kHz) | Limits per Standard Ratings table. Tested via bridge method, at 25 °C, 100 kHz | | | | | |
| Leakage current | After application of RV applied to capacitors for 5 min using a steady source of power with 1 kΩ resistor in series with the capacitor under test, leakage current at 25 °C is not more than described in. | | | | | |
| Operation temperatures | Rated voltage | - 55 °C / + 40 °C | 10 V | 8.2 V | 6.3 V | 4.0 V |
| | Category voltage | + 40 °C / + 85 °C | 6.3 V | 5.2 V | 4.0 V | 2.5 V |
| | Category voltage | + 85 °C / + 125 °C | 4 V | 3.3 V | 2.5 V | 1.6 V |





| POWER DISSIPATION | | |
|--------------------------|---------------|--|
| CASE CODE | HEIGHT | MAXIMUM PERMISSIBLE POWER DISSIPATION AT +25 °C (W) IN FREE AIR |
| C | 16H | 0.100 |
| C | 20H | 0.110 |
| M | 20H | 0.175 |
| X | 16H | 0.170 |
| X | 20H | 0.175 |

| STANDARD PACKAGING QUANTITY | | |
|------------------------------------|---------------|--------------------------------|
| CASE CODE | HEIGHT | UNITS PER REEL, 7" REEL |
| C | Any | 1000 |
| M | Any | 1000 |
| X | Any | 500 |

| PRODUCT INFORMATION | |
|--------------------------------|--|
| Conformal Coated Guide | www.vishay.com/doc?40150 |
| Pad Dimensions | |
| Packaging Dimensions | |
| Moisture Sensitivity (MSL) | www.vishay.com/doc?40135 |
| SELECTOR GUIDES | |
| Solid Tantalum Selector Guide | www.vishay.com/doc?49053 |
| Solid Tantalum Chip Capacitors | www.vishay.com/doc?40091 |
| FAQ | |
| Frequently Asked Questions | www.vishay.com/doc?40110 |



Guide for Conformal Coated Tantalum Capacitors

INTRODUCTION

Tantalum electrolytic capacitors are the preferred choice in applications where volumetric efficiency, stable electrical parameters, high reliability, and long service life are primary considerations. The stability and resistance to elevated temperatures of the tantalum / tantalum oxide / manganese dioxide system make solid tantalum capacitors an appropriate choice for today's surface mount assembly technology.

Vishay Sprague has been a pioneer and leader in this field, producing a large variety of tantalum capacitor types for consumer, industrial, automotive, military, and aerospace electronic applications.

Tantalum is not found in its pure state. Rather, it is commonly found in a number of oxide minerals, often in combination with Columbium ore. This combination is known as "tantalite" when its contents are more than one-half tantalum. Important sources of tantalite include Australia, Brazil, Canada, China, and several African countries. Synthetic tantalite concentrates produced from tin slags in Thailand, Malaysia, and Brazil are also a significant raw material for tantalum production.

Electronic applications, and particularly capacitors, consume the largest share of world tantalum production. Other important applications for tantalum include cutting tools (tantalum carbide), high temperature super alloys, chemical processing equipment, medical implants, and military ordnance.

Vishay Sprague is a major user of tantalum materials in the form of powder and wire for capacitor elements and rod and sheet for high temperature vacuum processing.

THE BASICS OF TANTALUM CAPACITORS

Most metals form crystalline oxides which are non-protecting, such as rust on iron or black oxide on copper. A few metals form dense, stable, tightly adhering, electrically insulating oxides. These are the so-called "valve" metals and include titanium, zirconium, niobium, tantalum, hafnium, and aluminum. Only a few of these permit the accurate control of oxide thickness by electrochemical means. Of these, the most valuable for the electronics industry are aluminum and tantalum.

Capacitors are basic to all kinds of electrical equipment, from radios and television sets to missile controls and automobile ignitions. Their function is to store an electrical charge for later use.

Capacitors consist of two conducting surfaces, usually metal plates, whose function is to conduct electricity. They are separated by an insulating material or dielectric. The dielectric used in all tantalum electrolytic capacitors is tantalum pentoxide.

Tantalum pentoxide compound possesses high-dielectric strength and a high-dielectric constant. As capacitors are being manufactured, a film of tantalum pentoxide is applied to their electrodes by means of an electrolytic process. The film is applied in various thicknesses and at various voltages and although transparent to begin with, it takes on different colors as light refracts through it. This coloring occurs on the tantalum electrodes of all types of tantalum capacitors.

Rating for rating, tantalum capacitors tend to have as much as three times better capacitance / volume efficiency than aluminum electrolytic capacitors. An approximation of the capacitance / volume efficiency of other types of capacitors may be inferred from the following table, which shows the dielectric constant ranges of the various materials used in each type. Note that tantalum pentoxide has a dielectric constant of 26, some three times greater than that of aluminum oxide. This, in addition to the fact that extremely thin films can be deposited during the electrolytic process mentioned earlier, makes the tantalum capacitor extremely efficient with respect to the number of microfarads available per unit volume. The capacitance of any capacitor is determined by the surface area of the two conducting plates, the distance between the plates, and the dielectric constant of the insulating material between the plates.

COMPARISON OF CAPACITOR DIELECTRIC CONSTANTS

| DIELECTRIC | ϵ DIELECTRIC CONSTANT |
|---------------------------|-----------------------------------|
| Air or vacuum | 1.0 |
| Paper | 2.0 to 6.0 |
| Plastic | 2.1 to 6.0 |
| Mineral oil | 2.2 to 2.3 |
| Silicone oil | 2.7 to 2.8 |
| Quartz | 3.8 to 4.4 |
| Glass | 4.8 to 8.0 |
| Porcelain | 5.1 to 5.9 |
| Mica | 5.4 to 8.7 |
| Aluminum oxide | 8.4 |
| Tantalum pentoxide | 26 |
| Ceramic | 12 to 400K |

In the tantalum electrolytic capacitor, the distance between the plates is very small since it is only the thickness of the tantalum pentoxide film. As the dielectric constant of the tantalum pentoxide is high, the capacitance of a tantalum capacitor is high if the area of the plates is large:

$$C = \frac{eA}{t}$$

where

C = capacitance

e = dielectric constant

A = surface area of the dielectric

t = thickness of the dielectric

Tantalum capacitors contain either liquid or solid electrolytes. In solid electrolyte capacitors, a dry material (manganese dioxide) forms the cathode plate. A tantalum lead is embedded in or welded to the pellet, which is in turn connected to a termination or lead wire. The drawings show the construction details of the surface mount types of tantalum capacitors shown in this catalog.



SOLID ELECTROLYTE TANTALUM CAPACITORS

Solid electrolyte capacitors contain manganese dioxide, which is formed on the tantalum pentoxide dielectric layer by impregnating the pellet with a solution of manganous nitrate. The pellet is then heated in an oven, and the manganous nitrate is converted to manganese dioxide.

The pellet is next coated with graphite, followed by a layer of metallic silver, which provides a conductive surface between the pellet and the can in which it will be enclosed.

After assembly, the capacitors are tested and inspected to assure long life and reliability. It offers excellent reliability and high stability for consumer and commercial electronics with the added feature of low cost.

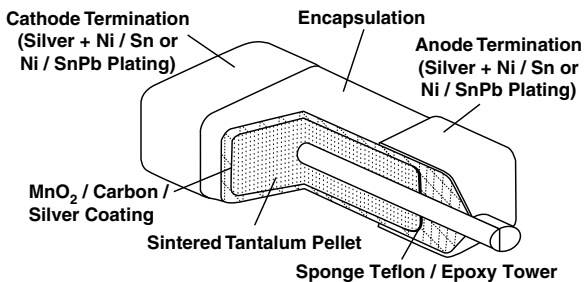
Surface mount designs of "Solid Tantalum" capacitors use lead frames or lead frameless designs as shown in the accompanying drawings.

TANTALUM CAPACITORS FOR ALL DESIGN CONSIDERATIONS

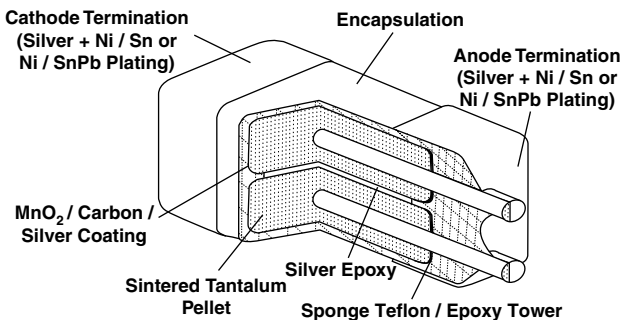
Solid electrolyte designs are the least expensive for a given rating and are used in many applications where their very small size for a given unit of capacitance is of importance. They will typically withstand up to about 10 % of the rated DC working voltage in a reverse direction. Also important are their good low temperature performance characteristics and freedom from corrosive electrolytes.

Vishay Sprague patented the original solid electrolyte capacitors and was the first to market them in 1956. Vishay Sprague has the broadest line of tantalum capacitors and has continued its position of leadership in this field. Data sheets covering the various types and styles of Vishay Sprague capacitors for consumer and entertainment electronics, industry, and military applications are available where detailed performance characteristics must be specified.

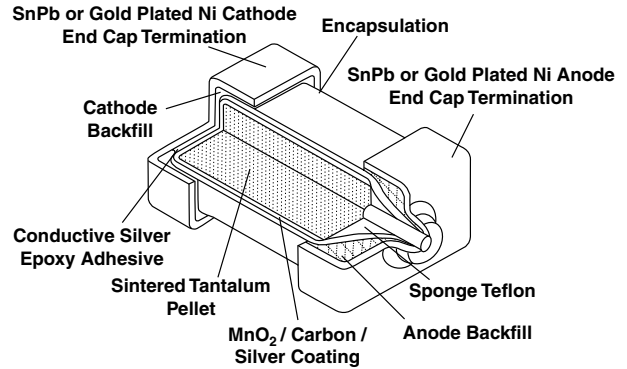
TYPE 195D, 591D, 592D / 592W, 594D, 595D, 695D, T95, 14002



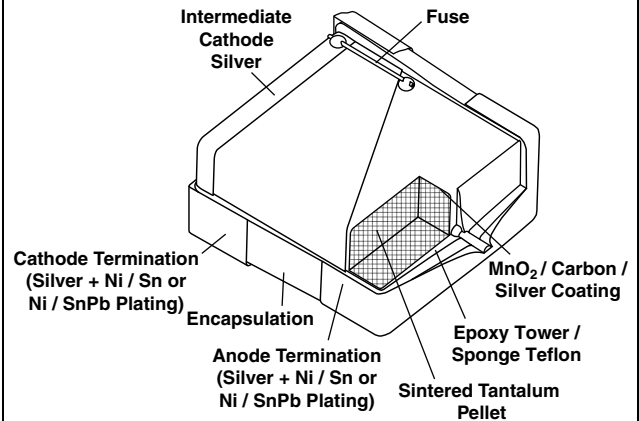
TYPE 597D / T97 / 13008



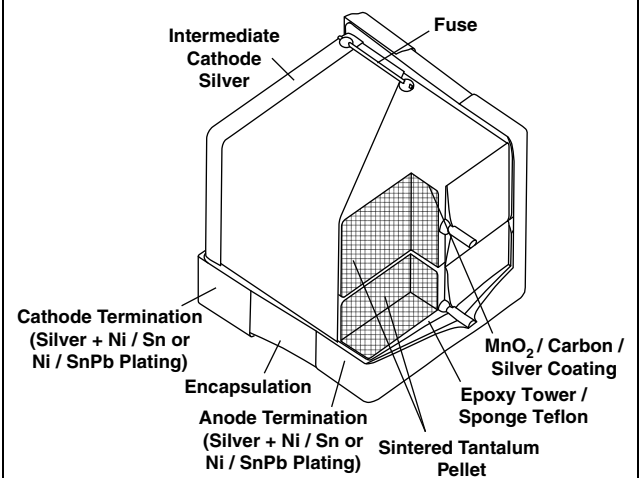
TYPE 194D



TYPE T96



TYPE T98














COMMERCIAL PRODUCTS

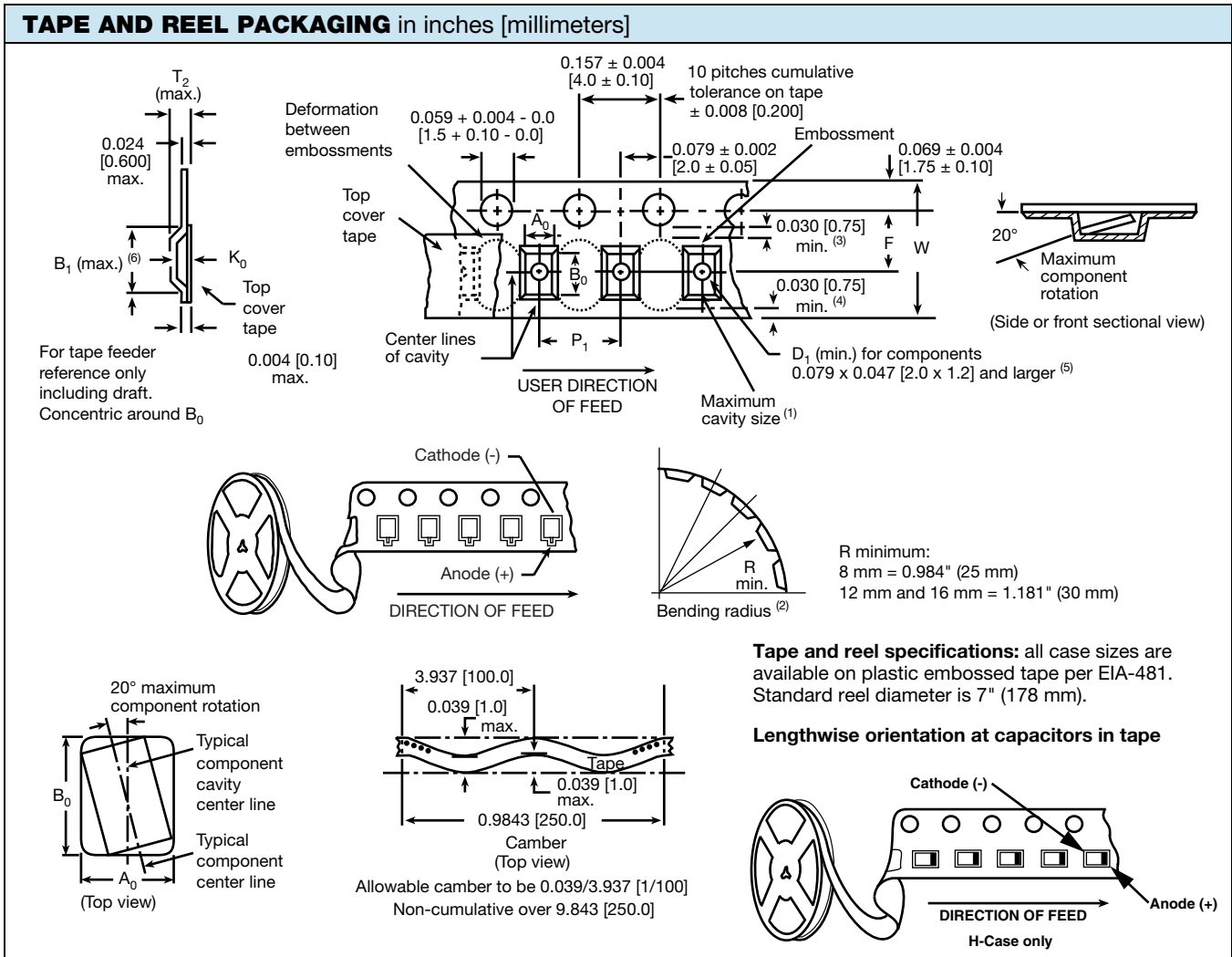
| SOLID TANTALUM CAPACITORS - CONFORMAL COATED | | | | | |
|--|---|--|----------------------------------|---------------------------|---------------------|
| SERIES | 592W | 592D | 591D | 595D | 594D |
| PRODUCT IMAGE | | | | | |
| TYPE | Surface mount TANTAMOUNT™ chip, conformal coated | | | | |
| FEATURES | Low profile, robust design for use in pulsed applications | Low profile, maximum CV | Low profile, low ESR, maximum CV | Maximum CV | Low ESR, maximum CV |
| TEMPERATURE RANGE | -55 °C to +125 °C (above 40 °C, voltage derating is required) | -55 °C to +125 °C (above 85 °C, voltage derating is required) | | | |
| CAPACITANCE RANGE | 330 µF to 2200 µF | 1 µF to 2200 µF | 1 µF to 1500 µF | 0.1 µF to 1500 µF | 1 µF to 1500 µF |
| VOLTAGE RANGE | 6 V to 10 V | 4 V to 50 V | 4 V to 50 V | 4 V to 50 V | 4 V to 50 V |
| CAPACITANCE TOLERANCE | ± 20 % | ± 10 %, ± 20 % | ± 10 %, ± 20 % | ± 10 %, ± 20 % | ± 10 %, ± 20 % |
| LEAKAGE CURRENT | 0.01 CV or 0.5 µA, whichever is greater | | | | |
| DISSIPATION FACTOR | 14 % to 45 % | 4 % to 50 % | 4 % to 50 % | 4 % to 20 % | 4 % to 20 % |
| CASE CODES | C, M, X | S, A, B, C, D, R, M, X | A, B, C, D, R, M | T, S, A, B, C, D, G, M, R | B, C, D, R |
| TERMINATION | 100 % matte tin | 100 % matte tin standard, tin / lead and gold plated available | | | |

| SOLID TANTALUM CAPACITORS - CONFORMAL COATED | | | | |
|--|---|--|--|--|
| SERIES | 597D | 695D | 195D | 194D |
| PRODUCT IMAGE | | | | |
| TYPE | TANTAMOUNT™ chip, conformal coated | | | |
| FEATURES | Ultra low ESR, maximum CV, multi-anode | Pad compatible with 194D and CWR06 | US and European case sizes | Industrial version of CWR06 / CWR16 |
| TEMPERATURE RANGE | -55 °C to +125 °C (above 85 °C, voltage derating is required) | | | |
| CAPACITANCE RANGE | 10 µF to 2200 µF | 0.1 µF to 270 µF | 0.1 µF to 330 µF | 0.1 µF to 330 µF |
| VOLTAGE RANGE | 4 V to 75 V | 4 V to 50 V | 2 V to 50 V | 4 V to 50 V |
| CAPACITANCE TOLERANCE | ± 10 %, ± 20 % | | | |
| LEAKAGE CURRENT | 0.01 CV or 0.5 µA, whichever is greater | | | |
| DISSIPATION FACTOR | 6 % to 20 % | 4 % to 8 % | 4 % to 8 % | 4 % to 10 % |
| CASE CODES | V, D, E, R, F, Z, M, H | A, B, D, E, F, G, H | C, S, V, X, Y, Z, R, A, B, D, E, F, G, H | A, B, C, D, E, F, G, H |
| TERMINATION | 100 % matte tin standard, tin / lead solder plated available | 100 % matte tin standard, tin / lead and gold plated available | | Gold plated standard; tin / lead solder plated and hot solder dipped available |

HIGH RELIABILITY PRODUCTS

| SOLID TANTALUM CAPACITORS - CONFORMAL COATED | | | | | |
|--|---|---|--|---|---|
| SERIES | CWR06 | CWR16 | CWR26 | 13008 | 14002 |
| PRODUCT IMAGE |  |  |  |  |  |
| TYPE | TANTAMOUNT™ chip, conformal coated | | | | |
| FEATURES | MIL-PRF-55365/4 qualified | MIL-PRF-55365/13 qualified | MIL-PRF-55365/13 qualified | DLA approved | |
| TEMPERATURE RANGE | -55 °C to +125 °C (above 85 °C, voltage derating is required) | | | | |
| CAPACITANCE RANGE | 0.10 µF to 100 µF | 0.33 µF to 330 µF | 10 µF to 100 µF | 10 µF to 1500 µF | 4.7 µF to 680 µF |
| VOLTAGE RANGE | 4 V to 50 V | 4 V to 35 V | 15 V to 35 V | 4 V to 63 V | 4 V to 50 V |
| CAPACITANCE TOLERANCE | ± 5 %, ± 10 %, ± 20 % | ± 5 %, ± 10 %, ± 20 % | ± 5 %, ± 10 %, ± 20 % | ± 10 %, ± 20 % | ± 10 %, ± 20 % |
| LEAKAGE CURRENT | 0.01 CV or 1.0 µA, whichever is greater | | | 0.01 CV or 0.5 µA, whichever is greater | |
| DISSIPATION FACTOR | 6 % to 10 % | 6 % to 10 % | 6 % to 12 % | 6 % to 20 % | 6 % to 14 % |
| CASE CODES | A, B, C, D, E, F, G, H | A, B, C, D, E, F, G, H | F, G, H | V, E, F, R, Z, D, M, H, N | B, C, D, R |
| TERMINATION | Gold plated; tin / lead; tin / lead solder fused | | | Tin / lead | |

| SOLID TANTALUM CAPACITORS - CONFORMAL COATED | | | | |
|--|---|---|---|---|
| SERIES | T95 | T96 | T97 | T98 |
| PRODUCT IMAGE |  |  |  |  |
| TYPE | TANTAMOUNT™ chip, Hi-Rel COTS, conformal coated | | | |
| FEATURES | High reliability | High reliability, built in fuse | High reliability, ultra low ESR, multi-anode | High reliability, ultra low ESR, built in fuse, multi-anode |
| TEMPERATURE RANGE | -55 °C to +125 °C (above 85 °C, voltage derating is required) | | | |
| CAPACITANCE RANGE | 0.15 µF to 680 µF | 10 µF to 680 µF | 10 µF to 2200 µF | 10 µF to 1500 µF |
| VOLTAGE RANGE | 4 V to 50 V | 4 V to 50 V | 4 V to 75 V | 4 V to 75 V |
| CAPACITANCE TOLERANCE | ± 10 %, ± 20 % | ± 10 %, ± 20 % | ± 10 %, ± 20 % | ± 10 %, ± 20 % |
| LEAKAGE CURRENT | 0.01 CV or 0.5 µA, whichever is greater | | | |
| DISSIPATION FACTOR | 4 % to 14 % | 6 % to 14 % | 6 % to 20 % | 6 % to 10 % |
| CASE CODES | A, B, C, D, R, S, V, X, Y, Z | R | V, E, F, R, Z, D, M, H, N | V, E, F, R, Z, M, H |
| TERMINATION | 100 % matte tin, tin / lead | | | |



Notes

- Metric dimensions will govern. Dimensions in inches are rounded and for reference only
- (1) A_0 , B_0 , K_0 , are determined by the maximum dimensions to the ends of the terminals extending from the component body and / or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A_0 , B_0 , K_0) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°
- (2) Tape with components shall pass around radius "R" without damage. The minimum trailer length may require additional length to provide "R" minimum for 12 mm embossed tape for reels with hub diameters approaching N minimum
- (3) This dimension is the flat area from the edge of the sprocket hole to either outward deformation of the carrier tape between the embossed cavities or to the edge of the cavity whichever is less
- (4) This dimension is the flat area from the edge of the carrier tape opposite the sprocket holes to either the outward deformation of the carrier tape between the embossed cavity or to the edge of the cavity whichever is less
- (5) The embossed hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location shall be applied independent of each other
- (6) B_1 dimension is a reference dimension tape feeder clearance only



| CARRIER TAPE DIMENSIONS in inches [millimeters] | | | | | | |
|---|--|---|--------------------------------|--------------------------------|-------------------------------|---------------------|
| TAPE WIDTH | W | D ₀ | P ₂ | F | E ₁ | E ₂ min. |
| 8 mm | 0.315 + 0.012 / - 0.004 [8.0 + 0.3 / - 0.1] | 0.059 + 0.004 / - 0 [1.5 + 0.1 / - 0] | 0.078 ± 0.0019 [2.0 ± 0.05] | 0.14 ± 0.0019 [3.5 ± 0.05] | 0.324 ± 0.004 [1.75 ± 0.1] | 0.246 [6.25] |
| 12 mm | 0.479 + 0.012 / - 0.004 [12.0 + 0.3 / - 0.1] | | | 0.216 ± 0.0019 [5.5 ± 0.05] | | 0.403 [10.25] |
| 16 mm | 0.635 + 0.012 / - 0.004 [16.0 + 0.3 / - 0.1] | | 0.078 ± 0.004 [2.0 ± 0.1] | 0.295 ± 0.004 [7.5 ± 0.1] | | 0.570 [14.25] |
| 24 mm | 0.945 ± 0.012 [24.0 ± 0.3] | | | 0.453 ± 0.004 [11.5 ± 0.1] | | 0.876 [22.25] |

| CARRIER TAPE DIMENSIONS in inches [millimeters] | | | | | |
|---|-----------|--------------------------------|-------------------------------|---------------------|---------------------|
| TYPE | CASE CODE | TAPE WIDTH W IN mm | P ₁ | K ₀ max. | B ₁ max. |
| 592D 592W 591D | A | 8 | 0.157 ± 0.004 [4.0 ± 0.10] | 0.058 [1.47] | 0.149 [3.78] |
| | B | 12 | | 0.088 [2.23] | 0.166 [4.21] |
| | C | 12 | 0.315 ± 0.004 [8.0 ± 0.10] | 0.088 [2.23] | 0.290 [7.36] |
| | D | 12 | | 0.088 [2.23] | 0.300 [7.62] |
| | M | 16 | | 0.091 [2.30] | 0.311 [7.90] |
| | R | 12 | | 0.088 [2.23] | 0.296 [7.52] |
| | S | 8 | 0.157 ± 0.004 [4.0 ± 0.10] | 0.058 [1.47] | 0.139 [3.53] |
| | T | 12 | 0.088 [2.23] | 0.166 [4.21] | |
| X | 24 | 0.472 ± 0.004 [12.0 ± 0.10] | 0.011 [2.72] | 0.594 [15.1] | |
| 595D 594D | A | 8 | 0.157 ± 0.004 [4.0 ± 0.10] | 0.063 [1.60] | 0.152 [3.86] |
| | B | 12 | | 0.088 [2.23] | 0.166 [4.21] |
| | C | 12 | 0.315 ± 0.004 [8.0 ± 0.10] | 0.118 [2.97] | 0.290 [7.36] |
| | D | 12 | | 0.119 [3.02] | 0.296 [7.52] |
| | G | 12 | | 0.111 [2.83] | 0.234 [5.95] |
| | H | 12 | | 0.098 [2.50] | 0.232 [5.90] |
| | M | 12 | 0.157 ± 0.004 [4.0 ± 0.10] | 0.085 [2.15] | 0.152 [3.85] |
| | R | 12 | 0.315 ± 0.004 [8.0 ± 0.10] | 0.148 [3.78] | 0.296 [7.52] |
| | S | 8 | 0.157 ± 0.004 [4.0 ± 0.10] | 0.058 [1.47] | 0.149 [3.78] |
| | T | 8 | | 0.054 [1.37] | 0.093 [2.36] |
| 695D | A | 8 | 0.157 ± 0.004 [4.0 ± 0.10] | 0.058 [1.47] | 0.139 [3.53] |
| | B | 12 | | 0.059 [1.50] | 0.189 [4.80] |
| | D | 12 | | 0.063 [1.62] | 0.191 [4.85] |
| | E | 12 | | 0.074 [1.88] | 0.239 [6.07] |
| | F | 12 | 0.315 ± 0.004 [8.0 ± 0.10] | 0.075 [1.93] | 0.259 [6.58] |
| | G | 12 | 0.157 ± 0.004 [4.0 ± 0.10] | 0.109 [2.77] | 0.301 [7.65] |
| | H | 16 | 0.315 ± 0.004 [8.0 ± 0.10] | 0.124 [3.15] | 0.31 [7.87] |



| CARRIER TAPE DIMENSIONS in inches [millimeters] | | | | | |
|---|------------------|-------------------------------|-------------------------------|---------------------|---------------------|
| TYPE | CASE CODE | TAPE WIDTH W IN mm | P ₁ | K ₀ max. | B ₁ max. |
| 195D | A | 8 | 0.157 ± 0.004 [4.0 ± 0.10] | 0.058 [1.47] | 0.139 [3.53] |
| | B | 12 | | 0.059 [1.50] | 0.189 [4.80] |
| | C | 8 | | 0.054 [1.37] | 0.093 [2.36] |
| | D | 12 | | 0.067 [1.70] | 0.179 [4.55] |
| | E | 12 | | 0.074 [1.88] | 0.239 [6.07] |
| | F | 12 | 0.315 ± 0.004 [8.0 ± 0.10] | 0.076 [1.93] | 0.259 [6.58] |
| | G | 12 | 0.157 ± 0.004 [4.0 ± 0.10] | 0.109 [2.77] | 0.301 [7.65] |
| | H ⁽¹⁾ | 12 | 0.472 ± 0.004 [12.0 ± 0.1] | 0.122 [3.11] | 0.163 [4.14] |
| | R | 12 | 0.315 ± 0.004 [8.0 ± 0.10] | 0.149 [3.78] | 0.296 [7.52] |
| | S | 8 | 0.157 ± 0.004 [4.0 ± 0.10] | 0.058 [1.47] | 0.149 [3.78] |
| | V | 8 | | 0.060 [1.52] | 0.150 [3.80] |
| | X | 12 | | 0.069 [1.75] | 0.296 [7.52] |
| | Y | 12 | | 0.089 [2.26] | 0.296 [7.52] |
| | Z | 12 | | 0.114 [2.89] | 0.288 [7.31] |
| 194D CWR06 CWR16 CWR26 | A | 8 | 0.157 ± 0.004 [4.0 ± 0.10] | 0.069 [1.75] | 0.139 [3.53] |
| | B | 12 | | 0.073 [1.85] | 0.189 [4.80] |
| | C | 12 | | 0.069 [1.75] | 0.244 [6.20] |
| | D | 12 | | 0.068 [1.72] | 0.191 [4.85] |
| | E | 12 | 0.074 [1.88] | 0.239 [6.07] | |
| | F | 12 | 0.315 ± 0.004 [8.0 ± 0.10] | 0.091 [2.31] | 0.262 [6.65] |
| | G | 16 | | 0.134 [3.40] | 0.289 [7.34] |
| | H | 16 | | 0.129 [3.28] | 0.319 [8.10] |
| | | | | | |
| 597D T97 13008 | D | 16 | 0.317 ± 0.004 [8.0 ± 0.10] | 0.150 [3.80] | 0.313 [7.95] |
| | E | 16 | | 0.173 [4.40] | 0.343 [8.70] |
| | F | 16 | 0.476 ± 0.004 [12.0 ± 0.1] | 0.205 [5.20] | 0.309 [7.85] |
| | H | 16 | | 0.224 [5.70] | 0.313 [7.95] |
| | M | 16 | | 0.193 [4.90] | 0.339 [8.60] |
| | N | 16 | | 0.283 [7.20] | 0.323 [8.20] |
| | R | 16 | | 0.159 [4.05] | 0.313 [7.95] |
| | V | 12 | 0.317 ± 0.004 [8.0 ± 0.10] | 0.088 [2.23] | 0.300 [7.62] |
| Z | 16 | 0.476 ± 0.004 [12.0 ± 0.1] | 0.239 [6.06] | 0.311 [7.90] | |
| T95 | A | 8 | 0.157 ± 0.004 [4.0 ± 0.10] | 0.063 [1.60] | 0.152 [3.86] |
| | B | 12 | | 0.088 [2.23] | 0.166 [4.21] |
| | C | 12 | | 0.117 [2.97] | 0.290 [7.36] |
| | D | 12 | 0.317 ± 0.004 [8.0 ± 0.10] | 0.119 [3.02] | 0.296 [7.52] |
| | R | 12 | | 0.149 [3.78] | 0.296 [7.52] |
| | S | 8 | 0.157 ± 0.004 [4.0 ± 0.10] | 0.058 [1.47] | 0.149 [3.78] |
| | V | 8 | | 0.060 [1.52] | 0.150 [3.80] |
| | X | 12 | | 0.069 [1.75] | 0.296 [7.52] |
| | Y | 12 | | 0.089 [2.26] | 0.296 [7.52] |
| Z | 12 | 0.114 [2.89] | | 0.288 [7.31] | |
| 14002 | B | 12 | 0.157 ± 0.004 [4.0 ± 0.10] | 0.088 [2.23] | 0.166 [4.21] |
| | C | 12 | | 0.117 [2.97] | 0.290 [7.36] |
| | D | 12 | 0.317 ± 0.004 [8.0 ± 0.10] | 0.119 [3.02] | 0.296 [7.52] |
| | R | 12 | | 0.149 [3.78] | 0.296 [7.52] |
| T96 | R | 16 | 0.476 ± 0.004 [12.0 ± 0.1] | 0.159 [4.05] | 0.313 [7.95] |
| T98 | F | 16 | 0.476 ± 0.004 [12.0 ± 0.1] | 0.239 [6.06] | 0.311 [7.90] |
| | M | 16 | | 0.193 [4.90] | 0.339 [8.60] |
| | Z | 16 | | 0.272 [6.90] | 0.307 [7.80] |

Note

⁽¹⁾ H case only, packaging code T: lengthwise orientation at capacitors in tape



PAD DIMENSIONS in inches [millimeters]



| CASE CODE | WIDTH (A) | PAD METALLIZATION (B) | SEPARATION (C) |
|------------------------|--------------|--------------------------|----------------|
| 592D / W - 591D | | | |
| A | 0.075 [1.9] | 0.050 [1.3] | 0.050 [1.3] |
| B | 0.118 [3.0] | 0.059 [1.5] | 0.059 [1.5] |
| C | 0.136 [3.5] | 0.090 [2.3] | 0.122 [3.1] |
| D | 0.180 [4.6] | 0.090 [2.3] | 0.134 [3.4] |
| M | 0.256 [6.5] | Anode pad: 0.095 [2.4] | 0.138 [3.5] |
| | | Cathode pad: 0.067 [1.7] | |
| R | 0.240 [6.1] | Anode pad: 0.095 [2.4] | 0.118 [3.0] |
| | | Cathode pad: 0.067 [1.7] | |
| S | 0.067 [1.7] | 0.032 [0.8] | 0.043 [1.1] |
| X | 0.310 [7.9] | 0.120 [3.0] | 0.360 [9.2] |
| 595D - 594D | | | |
| T | 0.059 [1.5] | 0.028 [0.7] | 0.024 [0.6] |
| S | 0.067 [1.7] | 0.032 [0.8] | 0.043 [1.1] |
| A | 0.083 [2.1] | 0.050 [1.3] | 0.050 [1.3] |
| B | 0.118 [3.0] | 0.059 [1.5] | 0.059 [1.5] |
| C | 0.136 [3.5] | 0.090 [2.3] | 0.122 [3.1] |
| D | 0.180 [4.6] | 0.090 [2.3] | 0.134 [3.4] |
| G | 0.156 [4.05] | 0.090 [2.3] | 0.082 [2.1] |
| M | 0.110 [2.8] | 0.087 [2.2] | 0.134 [3.4] |
| R | 0.248 [6.3] | 0.090 [2.3] | 0.140 [3.6] |
| 195D | | | |
| A | 0.067 [1.7] | 0.043 [1.1] | 0.028 [0.7] |
| B | 0.063 [1.6] | 0.047 [1.2] | 0.047 [1.2] |
| C | 0.059 [1.5] | 0.031 [0.8] | 0.024 [0.6] |
| D | 0.090 [2.3] | 0.055 [1.4] | 0.047 [1.2] |
| E | 0.090 [2.3] | 0.055 [1.4] | 0.079 [2.0] |
| F | 0.140 [3.6] | 0.063 [1.6] | 0.087 [2.2] |
| G | 0.110 [2.8] | 0.059 [1.5] | 0.126 [3.2] |
| H | 0.154 [3.9] | 0.063 [1.6] | 0.140 [3.6] |
| N | 0.244 [6.2] | 0.079 [2.0] | 0.118 [3.0] |
| R | 0.248 [6.3] | 0.090 [2.3] | 0.140 [3.6] |
| S | 0.079 [2.0] | 0.039 [1.0] | 0.039 [1.0] |
| V | 0.114 [2.9] | 0.039 [1.0] | 0.039 [1.0] |
| X | 0.118 [3.0] | 0.067 [1.7] | 0.122 [3.1] |
| Y | 0.118 [3.0] | 0.067 [1.7] | 0.122 [3.1] |
| Z | 0.118 [3.0] | 0.067 [1.7] | 0.122 [3.1] |



PAD DIMENSIONS in inches [millimeters]

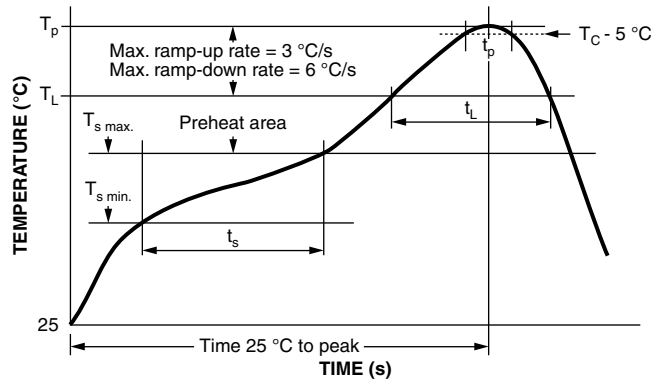


| CASE CODE | WIDTH (A) | PAD METALLIZATION (B) | SEPARATION (C) |
|--|--------------|-----------------------|----------------|
| CWR06 / CWR16 / CWR26 - 194D - 695D | | | |
| A | 0.065 [1.6] | 0.50 [1.3] | 0.040 [1.0] |
| B | 0.065 [1.6] | 0.70 [1.8] | 0.055 [1.4] |
| C | 0.065 [1.6] | 0.70 [1.8] | 0.120 [3.0] |
| D | 0.115 [2.9] | 0.70 [1.8] | 0.070 [1.8] |
| E | 0.115 [2.9] | 0.70 [1.8] | 0.120 [3.0] |
| F | 0.150 [3.8] | 0.70 [1.8] | 0.140 [3.6] |
| G | 0.125 [3.2] | 0.70 [1.8] | 0.170 [4.3] |
| H | 0.165 [4.2] | 0.90 [2.3] | 0.170 [4.3] |
| T95 | | | |
| B | 0.120 [3.0] | 0.059 [1.5] | 0.059 [1.5] |
| C | 0.136 [3.5] | 0.090 [2.3] | 0.120 [3.1] |
| D | 0.180 [4.6] | 0.090 [2.3] | 0.136 [3.47] |
| R | 0.248 [6.3] | 0.090 [2.3] | 0.140 [3.6] |
| S | 0.080 [2.03] | 0.040 [1.02] | 0.040 [1.02] |
| V | 0.114 [2.9] | 0.040 [1.02] | 0.040 [1.02] |
| X, Y, Z | 0.114 [2.9] | 0.065 [1.65] | 0.122 [3.1] |
| 14002 | | | |
| B | 0.120 [3.0] | 0.059 [1.5] | 0.059 [1.5] |
| C | 0.136 [3.5] | 0.090 [2.3] | 0.120 [3.1] |
| D | 0.180 [4.6] | 0.090 [2.3] | 0.136 [3.47] |
| R | 0.248 [6.3] | 0.090 [2.3] | 0.140 [3.6] |
| T96 | | | |
| R | 0.248 [6.3] | 0.090 [2.3] | 0.140 [3.6] |
| 597D - T97 - T98 - 13008 | | | |
| D, E, V | 0.196 [4.9] | 0.090 [2.3] | 0.140 [3.6] |
| F, R, Z | 0.260 [6.6] | 0.090 [2.3] | 0.140 [3.6] |
| M, H, N | 0.284 [7.2] | 0.090 [2.3] | 0.140 [3.6] |



RECOMMENDED REFLOW PROFILES

Capacitors should withstand reflow profile as per J-STD-020 standard, three cycles.



| PROFILE FEATURE | SnPb EUTECTIC ASSEMBLY | LEAD (Pb)-FREE ASSEMBLY |
|---|--|-------------------------|
| Preheat / soak | | |
| Temperature min. ($T_{s \text{ min.}}$) | 100 °C | 150 °C |
| Temperature max. ($T_{s \text{ max.}}$) | 150 °C | 200 °C |
| Time (t_s) from ($T_{s \text{ min.}}$ to $T_{s \text{ max.}}$) | 60 s to 120 s | 60 s to 120 s |
| Ramp-up | | |
| Ramp-up rate (T_L to T_p) | 3 °C/s max. | 3 °C/s max. |
| Liquidus temperature (T_L) | 183 °C | 217 °C |
| Time (t_L) maintained above T_L | 60 s to 150 s | 60 s to 150 s |
| Peak package body temperature (T_p) | Depends on type and case – see table below | |
| Time (t_p)* within 5 °C of the specified classification temperature (T_C) | 20 s | 30 s |
| Ramp-down | | |
| Ramp-down rate (T_p to T_L) | 6 °C/s max. | 6 °C/s max. |
| Time 25 °C to peak temperature | 6 min max. | 8 min max. |

PEAK PACKAGE BODY TEMPERATURE (T_p)

| TYPE / CASE CODE | PEAK PACKAGE BODY TEMPERATURE (T_p) | |
|---|---|------------------------|
| | SnPb EUTECTIC PROCESS | LEAD (Pb)-FREE PROCESS |
| 591D / 592D - all cases, except X25H, M and R cases | 235 °C | 260 °C |
| 591D / 592D - X25H, M and R cases | 220 °C | 250 °C |
| 594D / 595D - all cases except C, D, and R | 235 °C | 260 °C |
| 594D / 595D - C, D, and R case | 220 °C | 250 °C |
| T95 A, B, S, V, X, Y cases | 235 °C | 260 °C |
| T95 C, D, R, and Z cases | 220 °C | 250 °C |
| 14002 B case | 235 °C | n/a |
| 14002 C, D, and R cases | 220 °C | n/a |
| T96 R case | 220 °C | 250 °C |
| 195D all cases, except G, H, R, and Z | 235 °C | 260 °C |
| 195D G, H, R, and Z cases | 220 °C | 250 °C |
| 695D all cases, except G and H cases | 235 °C | 260 °C |
| 695D G, H cases | 220 °C | 250 °C |
| 597D, T97, T98 all cases, except V case | 220 °C | 250 °C |
| 597D, T97, T98 V case | 235 °C | 260 °C |
| 194D all cases, except H and G cases | 235 °C | 260 °C |
| 194D H and G cases | 220 °C | 250 °C |



GUIDE TO APPLICATION

- AC Ripple Current:** the maximum allowable ripple current shall be determined from the formula:

$$I_{RMS} = \sqrt{\frac{P}{R_{ESR}}}$$

where,

P = power dissipation in W at +25 °C as given in the tables in the product datasheets (Power Dissipation).

R_{ESR} = the capacitor equivalent series resistance at the specified frequency

- AC Ripple Voltage:** the maximum allowable ripple voltage shall be determined from the formula:

$$V_{RMS} = I_{RMS} \times Z$$

or, from the formula:

$$V_{RMS} = Z \sqrt{\frac{P}{R_{ESR}}}$$

where,

P = power dissipation in W at +25 °C as given in the tables in the product datasheets (Power Dissipation).

R_{ESR} = the capacitor equivalent series resistance at the specified frequency

Z = the capacitor impedance at the specified frequency

- 2.1 The sum of the peak AC voltage plus the applied DC voltage shall not exceed the DC voltage rating of the capacitor.
- 2.2 The sum of the negative peak AC voltage plus the applied DC voltage shall not allow a voltage reversal exceeding 10 % of the DC working voltage at +25 °C.
- Reverse Voltage:** solid tantalum capacitors are not intended for use with reverse voltage applied. However, they have been shown to be capable of withstanding momentary reverse voltage peaks of up to 10 % of the DC rating at 25 °C and 5 % of the DC rating at +85 °C.
- Temperature Derating:** if these capacitors are to be operated at temperatures above +25 °C, the permissible RMS ripple current shall be calculated using the derating factors as shown:

| TEMPERATURE | DERATING FACTOR |
|-------------|-----------------|
| +25 °C | 1.0 |
| +85 °C | 0.9 |
| +125 °C | 0.4 |

- Power Dissipation:** power dissipation will be affected by the heat sinking capability of the mounting surface. Non-sinusoidal ripple current may produce heating effects which differ from those shown. It is important that the equivalent I_{RMS} value be established when calculating permissible operating levels. (Power dissipation calculated using derating factor (see paragraph 4)).

- Attachment:**

- Soldering:** capacitors can be attached by conventional soldering techniques: vapor phase, convection reflow, infrared reflow, and hot plate methods. The soldering profile charts show recommended time / temperature conditions for soldering. Preheating is recommended. The recommended maximum ramp rate is 3 °C per second. Attachment with a soldering iron is not recommended due to the difficulty of controlling temperature and time at temperature. The soldering iron must never come in contact with the capacitor. For details see www.vishay.com/doc?40214.

- Recommended Mounting Pad Geometries:** the nib must have sufficient clearance to avoid electrical contact with other components. The width dimension indicated is the same as the maximum width of the capacitor. This is to minimize lateral movement.

- Cleaning (Flux Removal) After Soldering:** TANTAMOUNT™ capacitors are compatible with all commonly used solvents such as TES, TMS, Prelete, Chlorethane, Terpene and aqueous cleaning media. However, CFC / ODS products are not used in the production of these devices and are not recommended. Solvents containing methylene chloride or other epoxy solvents should be avoided since these will attack the epoxy encapsulation material.



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